CLAIMS

[Claim 1]

A packaging material comprising:

a laminated structure comprising a paper base material, an adhesive resin layer, a gas barrier layer, and a sealant layer in this order, wherein

the sealant layer includes an ethylene-methacrylic acid copolymer, and

the sealant layer has a melt flow rate of 20 g/10 minutes or more and 40 g/10 minutes or less measured under conditions of a temperature of 190° C and a load of 2.16 kg.

[Claim 2]

The packaging material according to claim 1, wherein the gas barrier layer has a film base material and a deposition layer,

the film base material includes a polypropylene film, and

the deposition layer contains an inorganic oxide.

[Claim 3]

The packaging material according to claim 2, wherein the deposition layer is disposed between the film base material and the adhesive resin layer.

[Claim 4]

The packaging material according to any one of claims 1 to 3, wherein the adhesive resin layer contains an ethylene-methacrylic acid copolymer, and

the adhesive resin layer has a melt flow rate of 3.0 g/10 minutes or more and 40 g/10 minutes or less measured under conditions of a temperature of 190°C and a load of 2.16 kg.

[Claim 5]

The packaging material according to any one of claims 1 to 4, wherein a resin contained in the sealant layer has a melting point of 105°C or less and a Vicat softening point of 95°C or less.

[Claim 6]

The packaging material according to any one of claims 1 to 5, wherein a resin contained in the sealant layer has a durometer hardness of 45 or more at 23°C with a type D durometer.

[Claim 7]

A container made of the packaging material according to any one of claims 1 to 6.